Notes:

1. No tracks or vias in the shaded "KEEP OUT" AREA.

2. No other track or signal within 0.020" of any contact pad.

3. Do not allow solder paste on the contact pads. It is essential to eliminate any hole in the solder paste-mask (solder stencil) layer. If this is not possible make the contact pads thru-hole with finished hole size of 0.008" or less.

4. To avoid ordering confusion, please specify DNL in your BOM.

5. The TC2050-CLIP board can attach to the three alignment pins from underneath the PCB to temporarily retain the cable in place.
NOTE:
Dimensions subject to change

TC2050-IDC-NL PLUG-OF-NAILS (TM) CABLE

ZONE REV
TC2050-IDC-NL 12/2/10 MS

END VIEW
2x5 .1" IDC CONNECTOR

END VIEW
10 PIN TAG-CONNECT

SIZE
A

FSCM NO.

DWG NO.

TC2050-IDC-NL

REV
A

SCALE
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Layout Problems to Avoid

Vias between contact pads

Do not deposit solder paste on contact pads. View Solder Paste Mask (Solder Stencil) layer in pad-stack and eliminate any hole.

Traces less than .02" away from contact pad or in "KEEP OUT" area